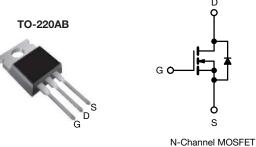
Vishay Siliconix



E Series Power MOSFET



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PRODUCT SUMMARY V_{DS} (V) at T_J max. 650 R_{DS(on)} max. (Ω) at 25 °C V_{GS} = 10 V 0.099 Q_q max. (nC) 150 24 Q_{gs} (nC) Q_{gd} (nC) 42 Configuration Single

FEATURES

- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	ТО-220АВ
Lead (Pb)-free	SiHP33N60E-E3
Lead (Pb)-free and Halogen-free	SiHP33N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	600	V	
Gate-Source Voltage			V _{GS}		
Continuous Durain Current (T. 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I _D	33	
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	V _{GS} at 10 V	T _C = 100 °C		21	A
Pulsed Drain Current ^a		I _{DM}	88		
Linear Derating Factor			2.2	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	793	mJ	
Maximum Power Dissipation		PD	278	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	n-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$			70	
Reverse Diode dV/dt ^d		dV/dt	12	V/ns	
Soldering Recommendations (Peak temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 7.5$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

S22-0235-Rev. G, 07-Mar-2022

1



COMPLIANT HALOGEN FREE



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.45	C/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V
Cata Sauraa Laakaga			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
Zava Cata Vialtaga Dirain Current		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 16.5 A	-	0.083	0.099	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} :	= 30 V, I _D = 16.5 A	-	11	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	3508	-	
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	156	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}			-	136	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	$V_{GS} = 0$	V, $V_{DS} = 0$ V to 480 V	-	468	-	
Total Gate Charge	Qg			-	100	150	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 16.5 A, V _{DS} = 480 V	-	24	-	nC
Gate-Drain Charge	Q _{gd}			-	42	-	
Turn-On Delay Time	t _{d(on)}		•	-	28	56	
Rise Time	t _r	V _{DD} =	480 V, I _D = 16.5 A	-	60	90	
Turn-Off Delay Time	t _{d(off)}	VDD = 400 V, 1D = 10.3 X		150	ns		
Fall Time	t _f			-	54	80	
Gate Input Resistance	Rg	f = 1	MHz, open drain	0.2	0.7	1.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	33	
Pulsed Diode Forward Current	I _{SM}	Ũ	integral reverse		-	88	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 16.5 A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	503	1006	ns
Reverse Recovery Charge	Q _{rr}		= 25 °C, I _F = I _S , 100 A/µs, V _B = 20 V	-	8.5	17	μC
Reverse Recovery Current	I _{RRM}		100 m µo, vR - 20 v	-	26	-	Α

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

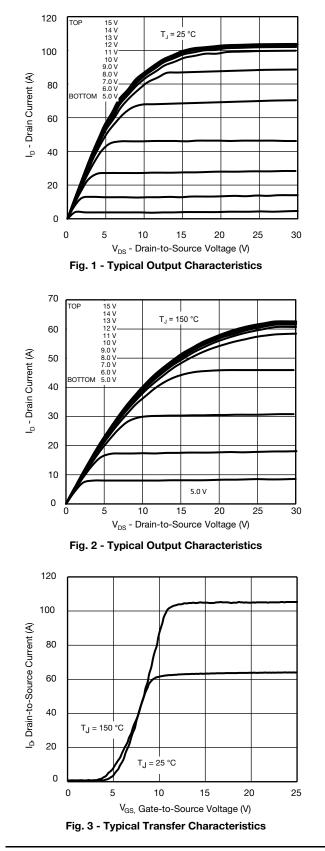
c. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



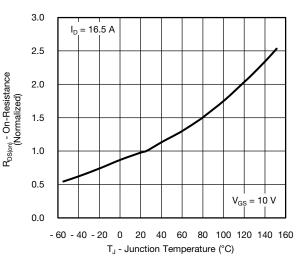


Fig. 4 - Normalized On-Resistance vs. Temperature

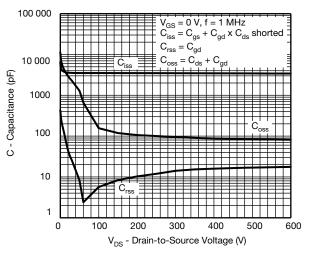
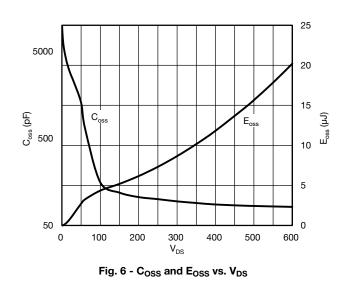


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S22-0235-Rev. G, 07-Mar-2022

3

Document Number: 91523

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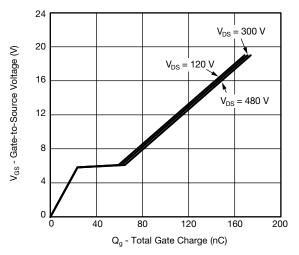


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

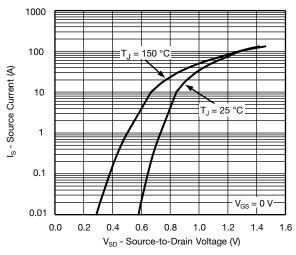
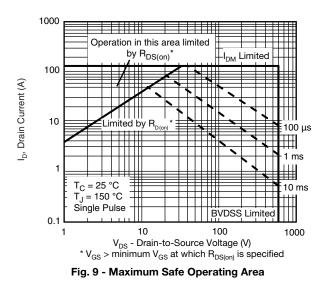


Fig. 8 - Typical Source-Drain Diode Forward Voltage



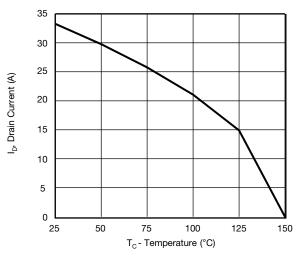


Fig. 10 - Maximum Drain Current vs. Case Temperature

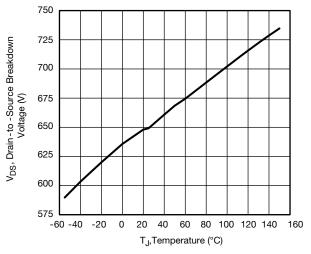


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

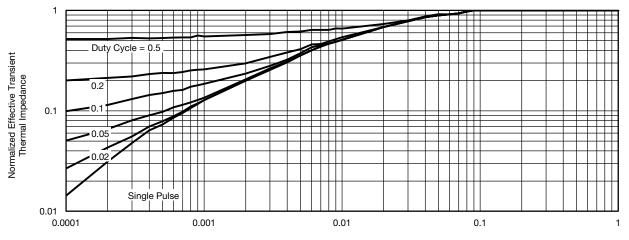
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Square Wave Pulse Duration (s) Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

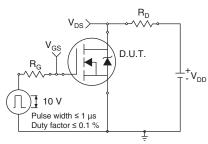


Fig. 13 - Switching Time Test Circuit

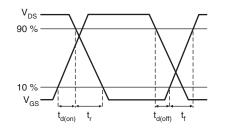


Fig. 14 - Switching Time Waveforms

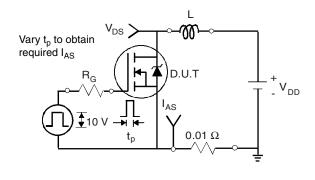


Fig. 15 - Unclamped Inductive Test Circuit

S22-0235-Rev. G, 07-Mar-2022

5

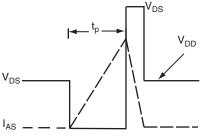


Fig. 16 - Unclamped Inductive Waveforms

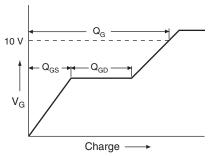
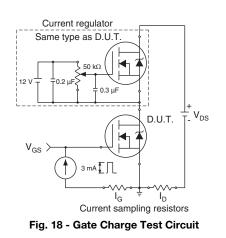


Fig. 17 - Basic Gate Charge Waveform





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Peak Diode Recovery dV/dt Test Circuit

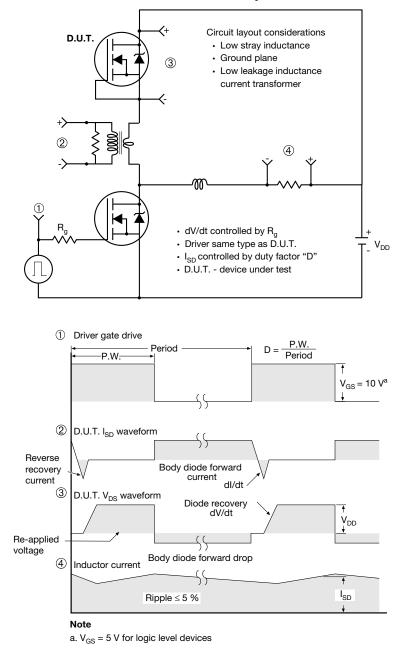


Fig. 19 - For N-Channel

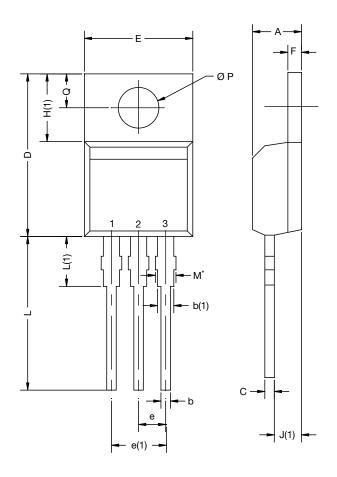
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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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